Beamtest at KEK in Feb. 1998

Analysis status - Sep. 98

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Introduction

Motivation

- Beamtest of irradiated detectors
- Comparison of p-in-n and n-in-n detectors from Hamamatsu Photonics
- Comparison with SINTEF p-in-n detectors

• Status in Sep. 98

- Fluence evaluation
- Bug identification and corrections
- Data analysis with calibration
- Charge collection comparison

Fluence evaluation

• Irradiation with 12 GeV protons

Brief history:

- Jan. 24, 1998 -- Irradiation execution
- Temperature: -5 °C (average)
- Stayed in the beamline till Feb. 4
- 5 days in room temp & 6 days warm-up at 28 $^\circ\text{C}$
- Beamtest: at -17 °C

Fluence evaluation with AI foils

- 5 x 5 matrix
- Absolute fluence was evaluated for the centre foil for the Be-7 activity
- Rest of the foils for relative fluence over the detector

- 4.16 x 10^{14} protons/cm², with an error of ~10%, i.e.,

(4.2 \pm 0.4) x 10^{14} protons/cm^2

- Fluence variation in positions (Fig.)

- In the beamtest, the beam was set to hit the centre of the detectors in an area of 2 cm x 2 cm

- The variation of fluence was from 4 to 5 x 10^{14} p/cm²



Detector-Hybrid Assembly

Irradiated detectors

Sample ID		Description
1)	SINTEF-p10	SINTEF p-in-n detector (labelled: p10, 293 μ m)
2)	STX41578-7	ATLAS97P p-in-n low resistivity
		(1k Ω •cm resistivity, Vdep=280 V measured)
3)	SDX35232-12	ATLAS97 n-in-n baseline

Detector-Hybrid combination

SINTEF p-in-n	Hybrid#1(4 chips)
Ham p-in-n(1kΩ•cm resistivity)	Hybrid#5 (4 chips but)
Ham n-in-n baseline	Hybrid#2 (2 chips)

- Readout was arranged so that the centres of the detectors were to be read out (Figure)

- Chips were labelled with LBIC's (64 channels/chip)

Setup

• Thermo-box

- Bottom plate: cooled with liquid cooling pipe
- Air volume: cooled with "refrigerator"
- Temperature: -17 °C

• Telescope - Detector sequence

- 1) Telescope
- 2) SINTEF p-in-n -- Hybrid#1
- 3) Ham p-in-n (low resistivity) -- Hybrid#5
- 4) Telescope
- 5) Ham n-in-n baseline -- Hybrid#2
- 6) disconnected
- 7) Telescope -- disconnected



Data

- Temperature: -17 °C
- Thresholds: 0.6 4.5 fC (nominal)
 - 0.6, 0.8, 1.2, 1.6, 2.0, 2.5, 3.0, 3.5, 4.0, 4.5
 - 30k events / threshold
- - Bias voltages: 125 500 V

125, 150, 175, 200, 225, 250, 275, 300, 325, 350, 375, 400, 425, 450, 475, 500

Preliminary results

CV measurements

- After warm-up (4 days room & 6 days at 28 °C)
- Temperature: -15 °C
- Depletion ~300 V in the n-in-n?
- No clear turning point in the p-in-n



Preliminary results (2)

• Bug identification and corrections

- Data communication errors, bits shifts -- This explained the loss of the efficiency of about 10%. Most of the corrupt data were excluded but there still corrupt data unidentified (There is no error detector code...)

- Wire-bonding sequence correction -- In a chip, there was a swap of bonds in a bunch

- After these corrections, most of the chips showed efficiency near 100% (at saturation)

• Electronics calibration with charge injection

- Looks reasonable, but,...

• Threshold scans and the medians

- Nominal thresholds were corrected with the electronics calibrations
- Threshold curves were fitted with an modified Error function

- 50% efficiency threshold was defined as the median, which is the median of the collected charges

- Efficiencies were obtained for

1) Average (or "all") region: without specifying the position between the strips

2) Strip region: \pm 20 μ m around the strip

3) Inter-strip region: $\pm 10~\mu \text{m}$ around the midway between the strips

CalFits: Chip 0 Runs 4100 to 4111

98/08/25 21.36



CalFits: Chip 0 Runs 4100 to 4111





CalFits: Chip 1 Runs 4100 to 4111

98/08/25 21.37



CalFits: Chip 1 Runs 4100 to 4111





CalFits: Chip 2 Runs 4100 to 4111





CalFits: Chip 3 Runs 4100 to 4111







eff.vb500.det1.chip2.

Charge collection as a function of bias voltage

• Median vs. Bias voltage

- By detectors and chips
- Sintef p10: det 0, chip 2, 3, 5 (4 was sick and excluded)
- HamP: det 1, chip 0, 1, 2, 3
- HamN: det 2, chip 0, 1, 2, 3

(Figures)

- Charge collection of the p-on-n detectors did not saturate even at 500V

- Charge collection of the n-on-n detector showed saturation above 300 V, although there were very slow increases up to 500 V

- At 500V, the medians reached at 3.5 fC in most of the chips

- A few chips showed discrepancy, saturation at 3 fC, 4 fC, 4.5 fC, e.g.



zq50detz0.zchipz3.



zq50detz1.zchipz0.



zq50detz1.zchipz2.







zq50detz2.zchipz2.



zq50detz2.zchipz3.

Rescaling the charge scale

• Average of the medians of 450, 475, 500 V to be 3.5 fC



q50det0.chip3.



q50det1.chip0.





q50det2.chip0.



q50det2.chip2.



Comparison of charge collection averaged over the detectors

(Figure)

- There was a clear difference in the charge collection (per single strip) between the n-on-n and the p-on-n detectors

- From the n-on-n detector, the full depletion voltage would be estimated to be about 350 V

- There was no big difference between the Sintef p10 and HamP, but there was difference, higher charge collection in Sintef



Efficiencies at 1 fC

- Efficiency at 1fC was interpolated from the Efficiencies nearby thresholds

- Figures shown for comparing the chips aligned



SinP10chip3HamPchip1HamNchip1

Vbias(V)



SinP10chip5HamPchip3HamNchip3

Charge collection ratios between the strip and the inter-strip regions

• Ratio = Median (Inter-strip) / Median (Strip)

(Figure)

• Observations:

- n-on-n: Constant ratio over the bias voltages from 100V to 500V

- p-on-n: Ratio decreased below 400 V, from 0.9 to 0.75 at 200 V



Future plans?

- More accurate estimation of the bias voltage per detector
 - Voltage drop by the resistance in the bias supply lines
- Detector thickness correction
 - Sintef is 293 μm thickness
 - Hamamatsu ? µm
 - ...